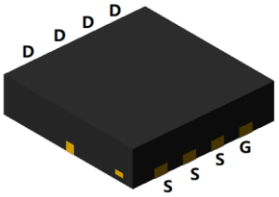
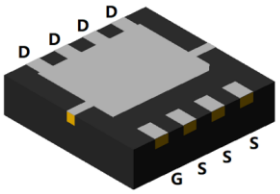
N-Channel Enhancement Mode Field Effect Transistor

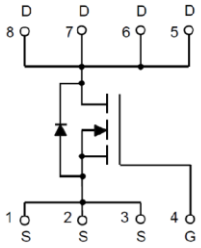


Top View



Bottom View

DFN3333-8L



Product Summary

- V_{DS} 100V
- I_D 3A
- $R_{DS(ON)}$(at V_{GS}=10V) ＜240mΩ
- $R_{DS(ON)}$(at V_{GS}=4.5V) ＜250mΩ
- 100% EAS Tested

General Description

- Trench Power MV MOSFET technology
- Voltage controlled small signal switch
- Fast Switching Speed
- Moisture Sensitivity Level 3
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- Power switching application
- DC-DC convertor

■ Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		V_{DS}	100	V
Gate-source Voltage		V_{GS}	±20	V
Drain Current	T_A=25℃	I_D	1	A
	T_A=100℃		0.6	
	T_C=25℃		3	
	T_C =100℃		1.9	
Pulsed Drain Current [A]		I_{DM}	10	A
Avalanche energy [B]		EAS	4	mJ
Total Power Dissipation [C]	T_A=25℃	P_D	1.5	W
	T_A=100℃		0.6	
	T_C=25℃		13.8	
	T_C =100℃		5.5	
Junction and Storage Temperature Range		T_J ,T_{STG}	-55～+150	℃

■Thermal resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient [C]	Steady-State	$R_{\theta JA}$	65	80	℃/W
Thermal Resistance Junction-to-Case	Steady-State	$R_{\theta JC}$	7.5	9	

■ Ordering Information (Example)

PREFERED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
Q03N10A	F1	Q03N10A	5000	10000	100000	13“ reel

■ Electrical Characteristics (T_J=25℃ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}= 0V, I_D=250μA	100	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=100V, V_{GS}=0V	-	-	1	μA
		V_{DS}=100V, V_{GS}=0V, Tj=150℃	-	-	100	
Gate-Body Leakage Current	I_{GSS}	V_{GS}= ±20V, V_{DS}=0V	-	-	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}= V_{GS}, I_D=250μA	1.1	1.8	3.0	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	V_{GS}=10V, I_D=3A	-	185	240	mΩ
		V_{GS}=4.5V, I_D=1A	-	190	250	
Diode Forward Voltage	V_{SD}	I_S=3A, V_{GS}=0V	-	0.8	1.2	V
Gate resistance	R_G	f=1MHz	-	1.7	-	Ω
Maximum Body-Diode Continuous Current	I_S		-	-	3	A
Dynamic Parameters						
Input Capacitance	C_{iss}	V_{DS}=50V, V_{GS}=0V, f=1MHz	-	380	-	pF
Output Capacitance	C_{oss}		-	15	-	
Reverse Transfer Capacitance	C_{rss}		-	10	-	
Switching Parameters						
Total Gate Charge	Q_g	V_{GS}=10V, V_{DS}=50V, I_D=1A	-	8	-	nC
Gate-Source Charge	Q_{gs}		-	1	-	
Gate-Drain Charge	Q_{gd}		-	1.6	-	
Reverse Recovery Charge	Q_{rr}	I_F=1A, di/dt=600A/us	-	22	-	nC
Reverse Recovery Time	t_{rr}		-	8	-	ns
Turn-on Delay Time	$t_{D(on)}$	V_{GS}=10V, V_{DD}=50V, I_D=1A R_{GEN}=2.2Ω	-	4.5	-	ns
Turn-on Rise Time	t_r		-	6.5	-	
Turn-off Delay Time	$t_{D(off)}$		-	12	-	
Turn-off fall Time	t_f		-	3.8	-	

A. Repetitive rating; pulse width limited by max. junction temperature.
B. T_J=25℃, V_{DD}=50V, V_G=10V, R_G=25Ω, L=0.5mH, IAS=4A.
C. P_d is based on max. junction temperature, using junction-case thermal resistance.
D. The value of $R_{\theta JA}$ is measured with the device mounted on the minimum recommend pad size, in the still air environment with T_A =25℃. The maximum allowed junction temperature of 150℃. The value in any given application depends on the user's specific board design.

■Typical Electrical and Thermal Characteristics Diagrams

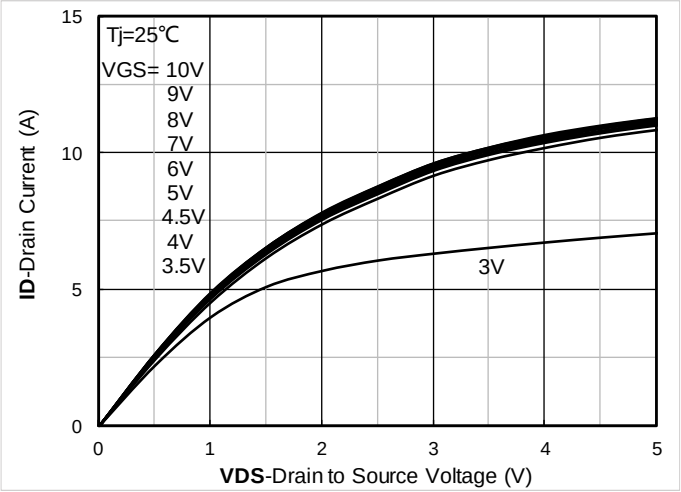


Figure 1. Output Characteristics

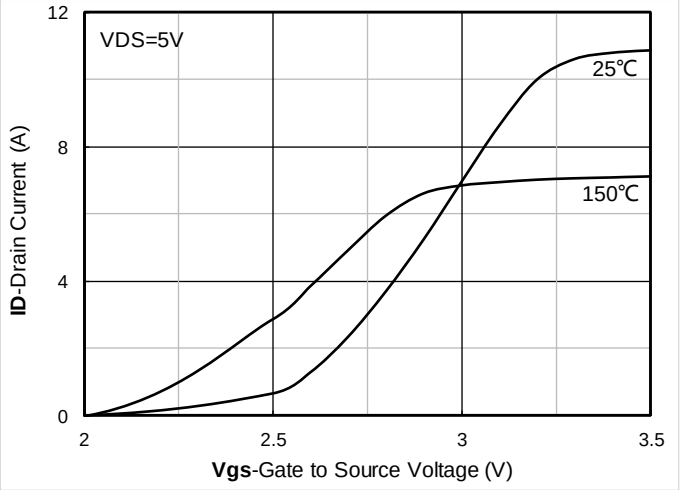


Figure 2. Transfer Characteristics

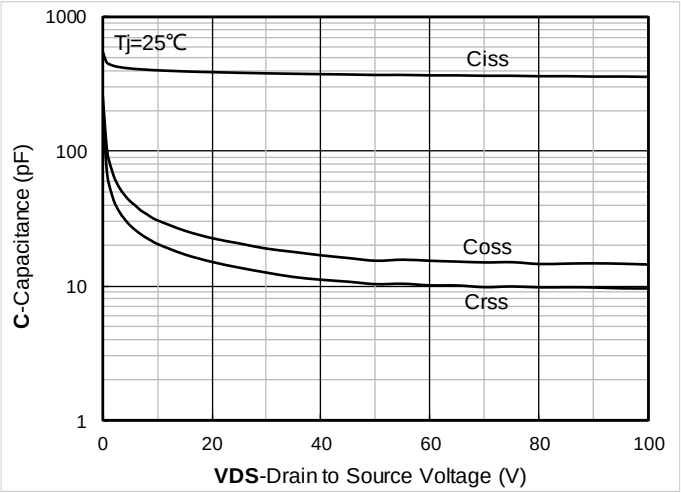


Figure 3. Capacitance Characteristics

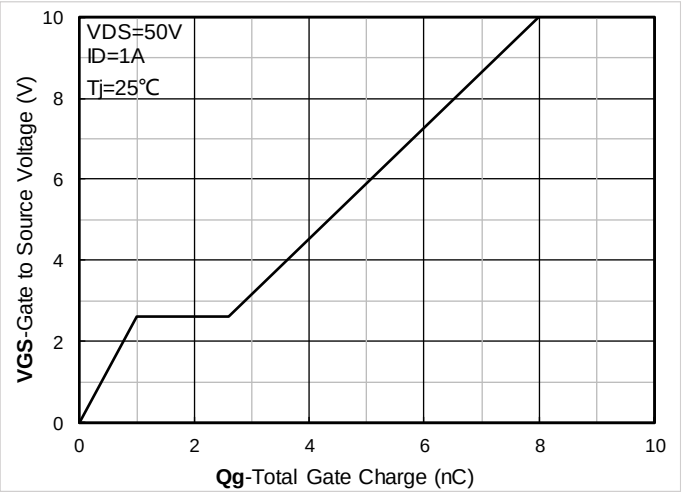


Figure 4. Gate Charge

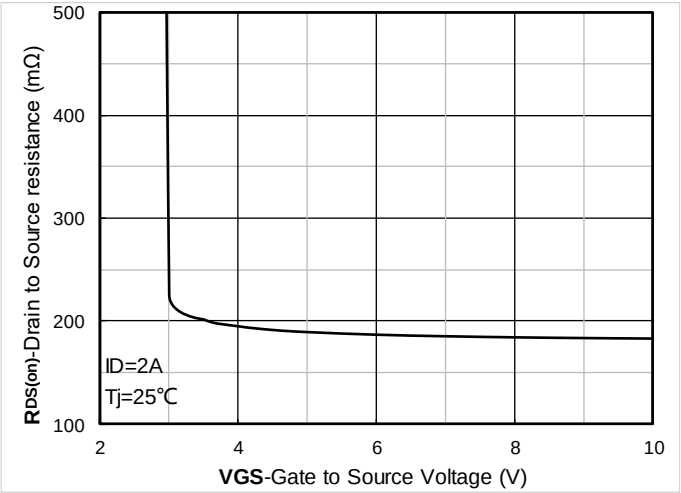


Figure 5. On-Resistance vs Gate to Source Voltage

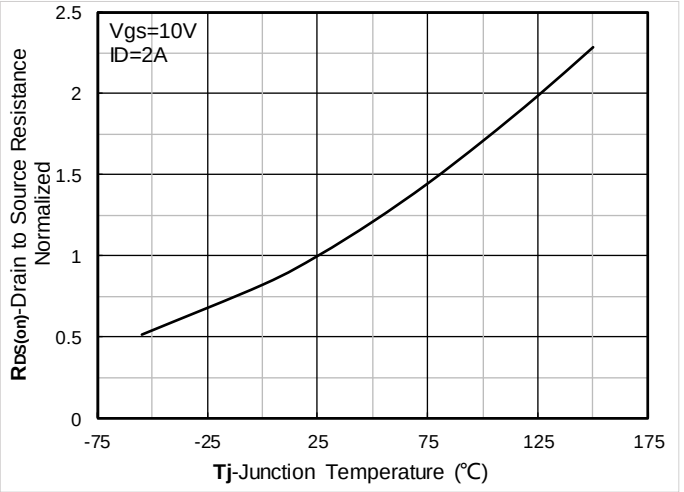


Figure 6. Normalized On-Resistance

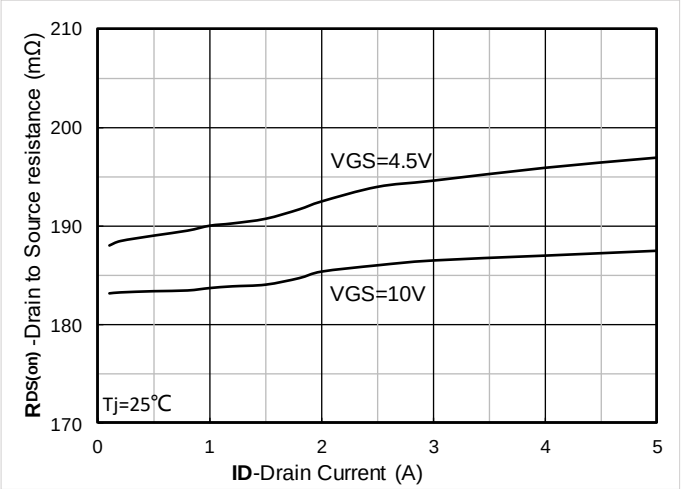


Figure 7. $R_{DS(on)}$ VS Drain Current

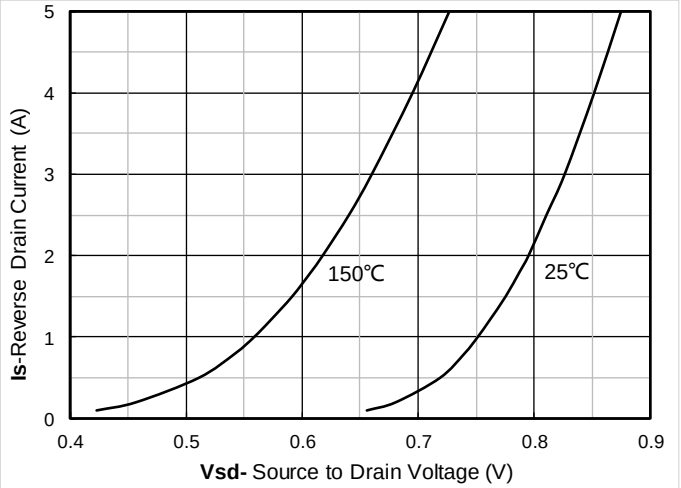


Figure 8. Forward characteristics of reverse diode

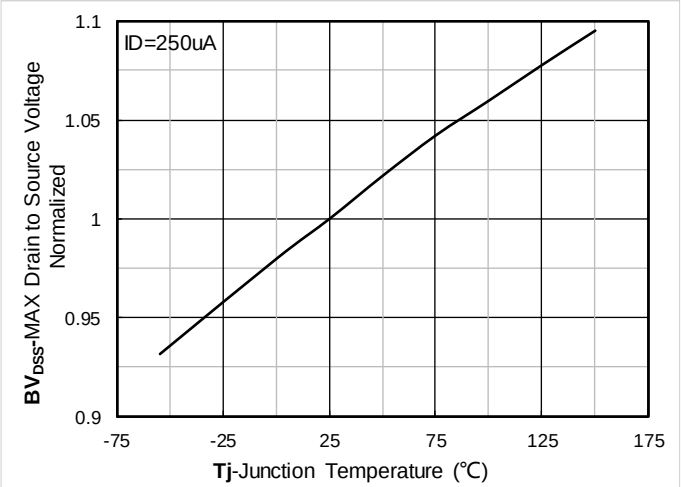


Figure 9. Normalized breakdown voltage

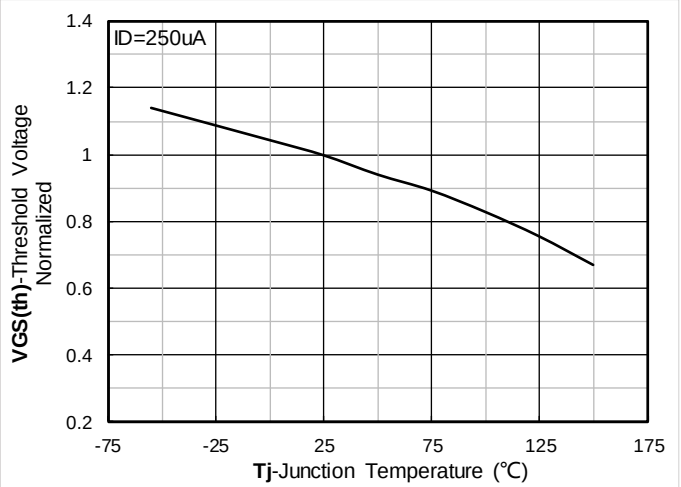


Figure 10. Normalized Threshold voltage

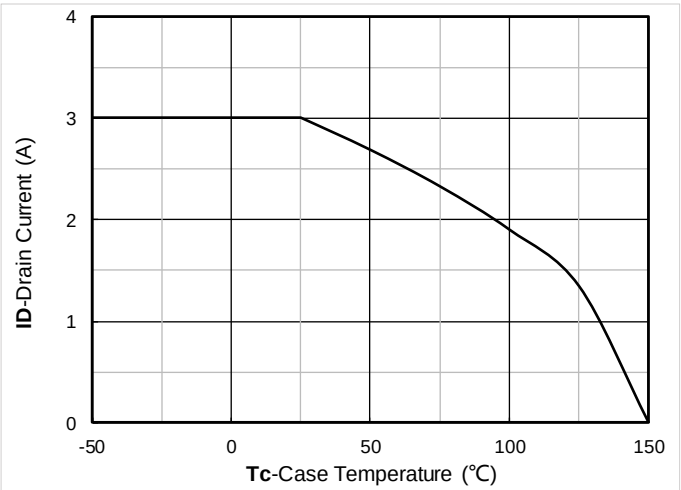


Figure 11. Current dissipation

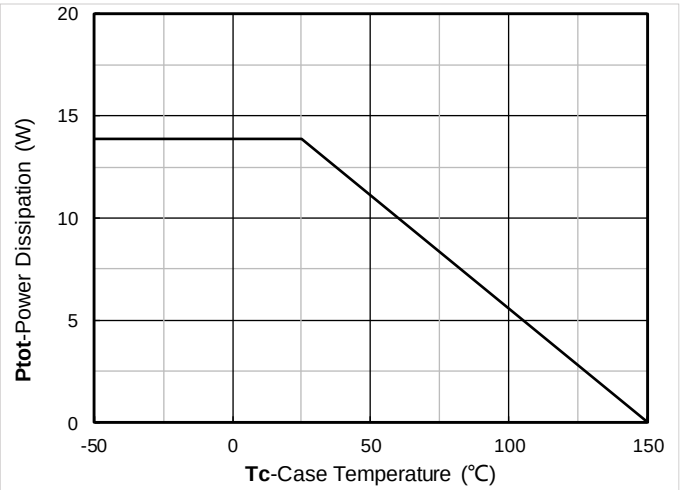


Figure 12. Power dissipation

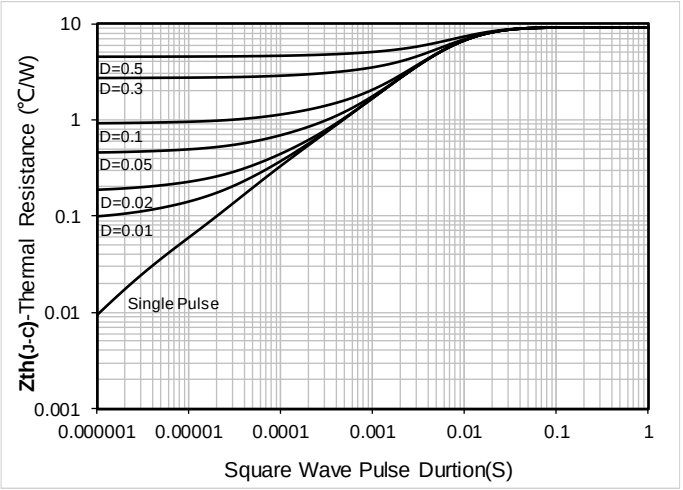


Figure 13. Maximum Transient Thermal Impedance

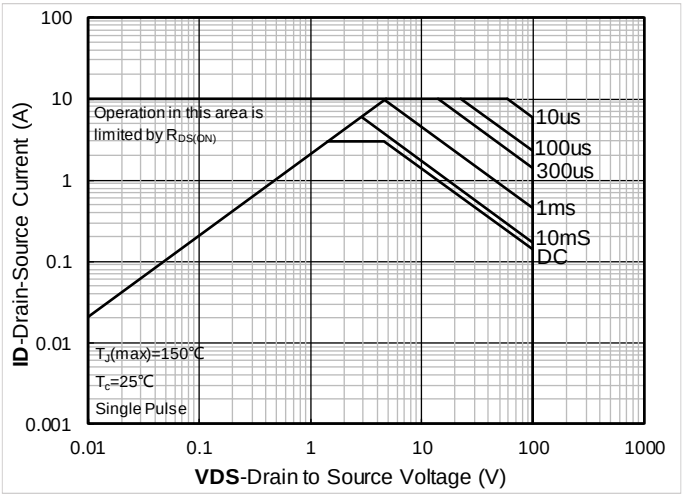
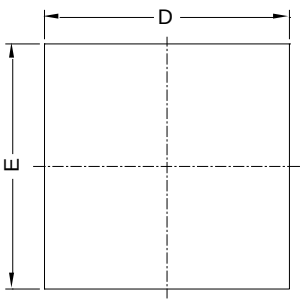
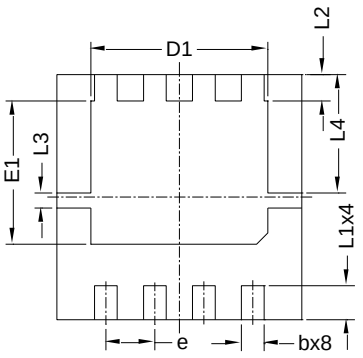


Figure 14. Safe Operation Area

■ DFN3333-8L-A-0.8MM Package information



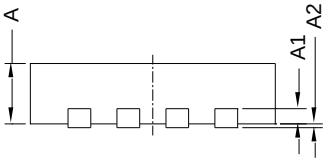
Top View
正面视图



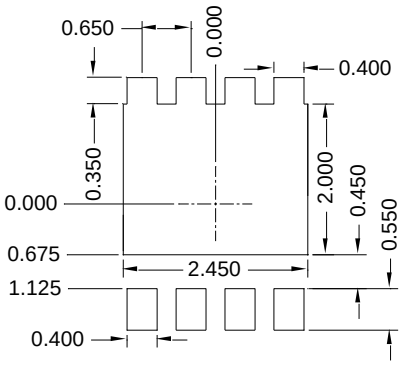
Bottom View
背面视图

SYMBOL	MILLIMETER		
	MIN	NOM	MAX
D	3.15	3.25	3.35
E	3.15	3.25	3.35
A	0.70	0.80	0.90
A1		0.20 BSC	
A2			0.10
D1	2.20	2.35	2.50
E1	1.80	1.90	2.00
L1	0.35	0.45	0.55
L2		0.35 BSC	
L3		0.20 BSC	
L4		1.57 BSC	
b	0.20	0.30	0.40
e		0.65 BSC	

Note:
1.Controlling dimension:in millimeters.
2.General tolerance:±0.10mm.
3.The pad layout is for reference purposes only.



Side View
侧面视图



Suggested Solder Pad Layout
Top View

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